

High Efficiency, 28V, 2.0A Sychronous Step Down Regulator For Dimmable LED Driver

Features

- Wide input range: 4.5V-28V
- Up to 2.0A Output current capability
- Low R_{DS(ON)} for internal switches
 High Side/Low Side: 125mΩ/75mΩ
- Fixed 1MHz switching frequency
- Cycle by cycle 2.8A valley current limit for low side
- High accuracy for low dimming scale
- Analog dimming with PWM input
- Over temperature protection
- Compact package: TSOT23-6

Descriptions

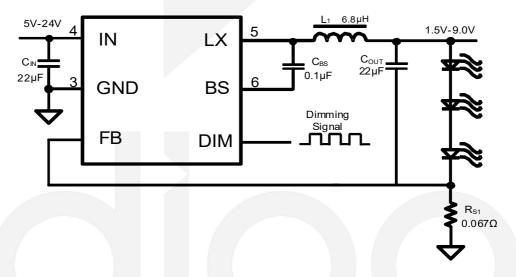
The DIO5718 is a high efficiency synchronous step-down LED regulator that achieves up to 2.0A output current. It operates at 1MHz and integrates two very low $R_{DS(ON)}$ power switches to minimize and reduce the external components.

It supports PWM dimming duty 1%-100% to achieve dimmable LED lighting application.

Applications

- DVR or NVR(IP Camera) System Application
- 24VDC Lighting

Typical Applications



Ordering Information

Order Part Number	Top Marking		T _A	Package	
DIO5718TST6	18YW	Green	-40 to 85°C	TSOT23-6	Tape & Reel, 3000



Pin Assignment

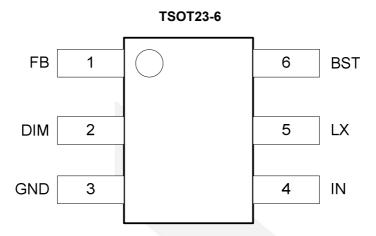


Figure 1 Top View

Pin Descriptions

Name	Description		
FB	Output current feedback pin. The output current: I _{OUT} =0.1V/ R _S		
DIM	Dimming signal input. The PWM dimming duty range: 1%-100%		
	Support the dimming frequency from 1KHz to 200KHz		
GND	Ground pin		
IN	Input supply pin		
LX	Switching node pin. Connect this pin to the inductor		
BST	Boot-strap pin. Supply for top side gate driver. Decouple this pin to LX with a 0.1µF ceramic cap		

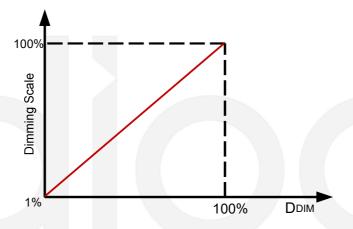


Figure 2 Ideal dimming curve of DIO5718



Absolute Maximum Ratings

Stresses beyond those listed under "Absolute Maximum Rating" may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other condition beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maxim rating conditions for extended periods may affect device reliability.

Symbol		Rating	Unit		
IN, DIM, FB			-0.3 to 30	V	
LX		-0.3 to 30	V		
BST-LX		-0.3 to 5.5	V		
Power Dissipation, P _D @ T _A =25°C	TSOT23-6		1.5	W	
Dookaga Thermal Pagistance	Θ_{JA}		66	°C/W	
Package Thermal Resistance	Θ_{JC}		15	°C/W	
Junction Temperature Range			-40 to 150	°C	
Lead Temperature		260	°C		
Storage Temperature Range		-65 to 150	°C		

Recommend Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended Operating conditions are specified to ensure optimal performance to the datasheet specifications. DIOO does not Recommend exceeding them or designing to Absolute Maximum Ratings.

Parameter	Rating	Unit	
Supply Voltage IN	4.5 to 28	V	
Junction Temperature Range	-40 to 125	°C	



Electrical Characteristics

Typical value: V_{IN} =12V, V_{OUT} =1.5V, I_{OUT} =1.0A, T_A = 25°C, unless otherwise specified.

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
IN Pin					•	
V _{IN}	Input Voltage Range		4.5		28.0	V
V _{UVLO}	IN UVLO Rising Threshold		4.0		4.3	V
V _{UVLO_HYS}	UVLO Hysteresis			0.4		V
lα	Quiescent Current	V _{DIM} =2V, V _{FB} =0.105V		0.3		mA
FB Pin						
V_{FB}	Feedback Reference Voltage	D _{DIM} =100%	97	100	103	mV
V _{FB_MIN}	Feedback Min Reference Voltage	D _{DIM} =1%		1		mV
Integrated	Power Switches					
R _{DS(ON)1}	High Side FET R _{DS(ON)}			125		mΩ
R _{DS(ON)2}	Low Side FET R _{DS(ON)}			75		mΩ
I _{LIM_LOW}	Low Side FET Valley Current Limit			2.8		Α
DIM Pin			•	•		
D _{DIM}	PWM Dimming Duty Range		1%		100%	
V _{DIM_ON}	Dimming ON Threshold				1.5	V
V_{DIM_OFF}	Dimming OFF Threshold		0.4			V
BST Pin						
V _{BST_LX}	Bias Voltage For High FET Driver	4.5V≤V _{IN} ≤28V		5		V
Fs	Operating Frequency			1.0		MHz
t _{ON_MIN}	Min ON Time			100		ns
D _{MAX}	Max Duty Cycle			80%		
Thermal St	nut Down					
T _{SD}	Thermal Shutdown Temperature			155		°C
T _{HYS}	Thermal Shutdown Hysteresis			20		°C



Functional Block Diagraph

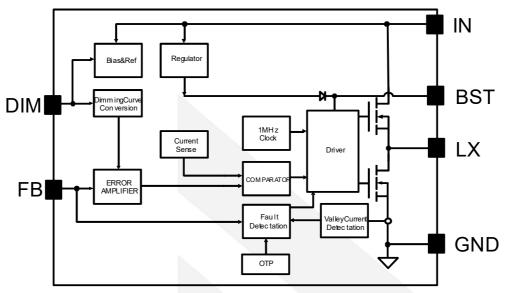


Figure 3. Functional Block Diagraph

Operation

The DIO5718 is a 28V and up to 2A constant output current capability synchronous buck regulator IC that integrates two very low $R_{DS(ON)}$ power switches to minimize the switching transition loss and conduction loss. The high switching frequency is used to minimize the external inductor and capacitor size to reduce the cost and simplify the design. It supports the PWM dimming duty from 1%-100% for DIM pin to achieve dimmable LED lighting application.

Application Information

Current Sensing Resistor R_{S1}

Choose the proper R_{S1} to program the output current I_{OUT}.

$$R_{S1} = \frac{0.1V}{I_{OUT}}$$

Input Capacitor CIN

The ripple current through input capacitor is calculated as:

$$I_{CIN_RMS} = I_{OUT} \times \sqrt{D \times (1-D)}$$

A typical X7R or better grade ceramic capacitor with suitable capacitance should be chosen to handle this ripple current well. To minimize the potential noise problem, place this ceramic capacitor close to the IN and GND pins. Caution should be taken to minimize the loop area formed by C_{IN} and IN/GND pin.



Output Capacitor Cout

The output capacitor is selected to improve the loop stability and handle the output current ripple noise requirements. For the best performance, it is recommended to use a X7R or better grade ceramic capacitor greater than 10µF capacitance.

Main Inductor L₁

There are several considerations in choosing this inductor.

- 1) Select the proper inductance to ensure the lop stability.
- 2) It is suggested to choose the ripple current to be about 40% of the maximum output current as long as the loop stability allows. The inductance is calculated as:

$$L_1 = \frac{V_{OUT} \times (1 - \frac{V_{OUT}}{V_{IN, MAX}})}{F_S \times I_{OUT, MAX} \times 40\%}$$

Where F_S is the switching frequency and I_{OUT,MAX} is the full scale LED current.

3) The saturation current rating of the inductor must be selected to be greater than the peak inductor current under full load conditions.

$$I_{SAT,MIN} > I_{OUT,MAX} + \frac{V_{OUT} \times (1 - \frac{V_{OUT}}{V_{IN,MAX}})}{2 \times F_S \times L_1}$$

Boost-strap Capacitor CBST

This capacitor provides the gate driver voltage for internal high side MOSEFET. A low ESR more than 100nF ceramic capacitor connected between BST pin and LX pin is recommended.

Dimming Performance

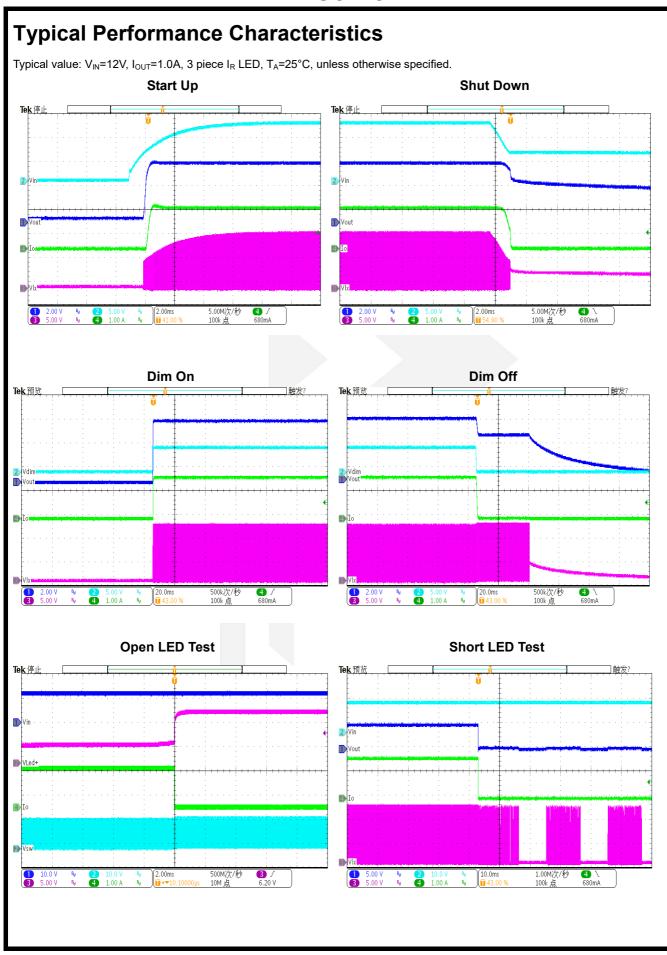
The DIM pin is used to regulate output current by the PWM signal, which supports the frequency from 1KHz to 200KHz. The logic high voltage is 1.5V and the logic low voltage is 0.4V. The DIM duty from 1% to 100%, the output current will be 1%-100%, the ideal dimming curve shows as figure 2.

Layout

For the best efficiency and minimum noise problems,

- 1) It is desirable to maximize the PCB copper area connecting to GND pin to achieve the best thermal and noise performance. If the board space allowed, a ground plane is highly desirable.
- 2) C_{IN} must be close to the pins IN and GND. The loop area formed by C_{IN} and GND must be minimized.
- 3) The PCB copper area associated with LX pin must be minimized to avoid the potential noise problem.
- 4) The FB pin must not be adjacent to the LX line on the PCB layout to avoid the noised problem.







CONTACT US

Dioo is a professional design and sales corporation for high-quality and performance analog semiconductors. The company focuses on industry markets, such as, cell phone, handheld products, laptop, and medical equipment and so on. Dioo's product families include analog signal processing and amplifying, LED drivers and charger IC. Go to http://www.dioo.com for a complete list of Dioo product families

For additional product information, or full datasheet, please contact with our Sales Department or Representatives.

